

## FEATURES

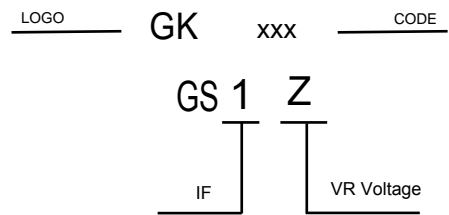
- \* Ideal for surface mount applications
- \* Easy pick and place
- \* Built-in strain relief
- \* High surge current capability

## MECHANICAL DATA

- \* Case: Molded plastic
- \* Epoxy: UL 94V-0 rate flame retardant
- \* Terminals: Solder plated, solderable per MIL-STD-202F method 208 guranteed
- \* Polarity: Color band denotes cathode end
- \* Mounting position: Any
- \* Weight: 0.063 gram



VOLTAGE RANGE  
2000 Volts  
CURRENT  
1.0 Ampere



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

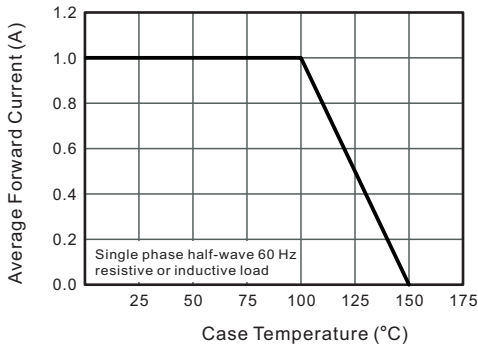
Rating 25°C ambient temperature unless otherwise specified.  
Single phase half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Parameter	Symbols	GS1Z	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	2000	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1	A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	30	A
Maximum Instantaneous Forward Voltage at 1 A	$V_F$	1.15	V
Maximum Reverse Current $T_J = 25\text{ }^\circ\text{C}$ $T_J = 125\text{ }^\circ\text{C}$	$I_R$	5 50	$\mu\text{A}$
Typical Junction Capacitance <sup>1)</sup>	$C_j$	20	pF
Typical Thermal Resistance <sup>2)</sup>	$R_{\theta JA}$	95	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{stg}$	-55 ~ +150	$^\circ\text{C}$

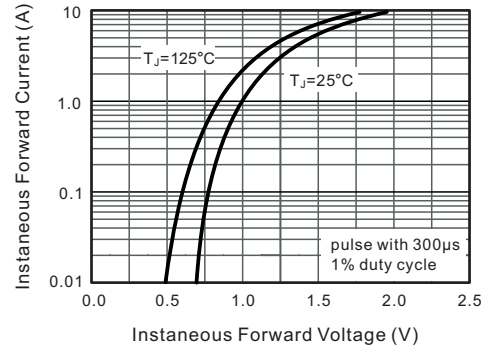
Measured at 1 MHz and applied reverse voltage of 4 V D.C  
P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

**RATING AND CHARACTERISTIC CURVES**

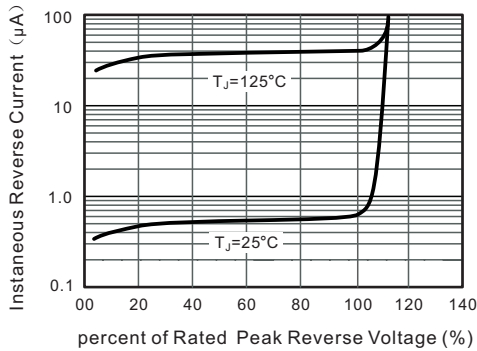
**FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE**



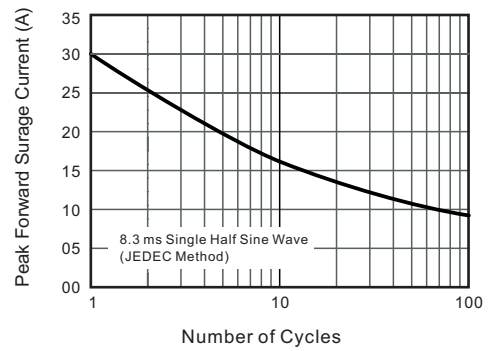
**FIG.2-TYPICAL FORWARD CHARACTERISTICS**



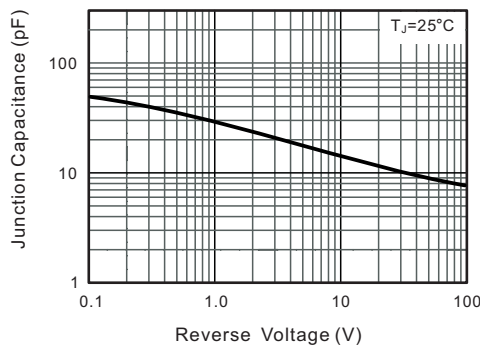
**FIG.3 - TYPICAL REVERSE CHARACTERISTICS**



**FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT**



**FIG.5-TYPICAL JUNCTION CAPACITANCE**



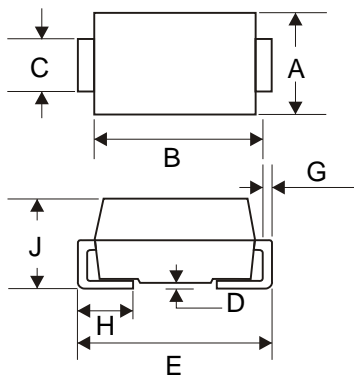
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ )(Liquid us)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_p$ )		8 min. Max
Do not exceed		+260°C

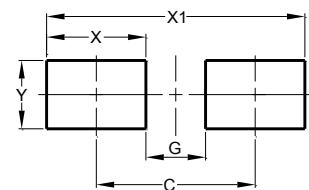


Package Dimensions & Suggested Pad Layout

SMA



SMA		
Dim	Min	Max
A	2.40	2.79
B	3.99	4.50
C	1.32	1.47
D	-	0.20
E	4.93	5.28
G	0.15	0.31
H	0.76	1.52
J	1.98	2.29
All Dimensions in mm		



Dimensions	Value (in mm)
C	4.20
G	1.90
X	2.30
X1	6.50
Y	2.00

Tape & reel specification

Tape		Symbol	Dimension (mm)		
		P0	4.00±0.20		
		P1	4.00±0.20		
		P2	2.00±0.20		
		D0	1.60±0.20		
		D1	1.60±0.20		
		E	1.75±0.20		
		F	5.50±0.15		
		W	12.00±0.25		
		A0	2.75±0.20		
		B0	5.25±0.20		
		K0	2.45±0.25		
		T	0.20±0.10		
		7" Reel		D2	176.0±5.0
				D3	55.0Min.
D4	14.0±2.5				
W1	14.0±2.5				
Quantity: 2000PCS					
13" Reel		D5	330.0±5.0		
		D6	73.0Min.		
		D7	14.0±2.5		
		W2	14.0±2.5		
		Quantity: 5000PCS			